TOSHIBA

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2020-05-07 Rev.2.0

RD Number: RD050

RD Title: TC78B016FTG Evaluation circuit BOM

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package	Not Mount
1	IC1	1	TC78B016FTG	TC78B016FTG	TOSHIBA	Motor driver IC	QFN36	
2	R1	1	27kΩ	—	-	Chip resistor		
3	R3	1	10kΩ	—	-	Leaded resistor		
4	R4	1	10kΩ	—	—	Leaded resistor		
5	R5	0	Not mount	—	—	Chip/Leaded resistor		√
6	R6	0	Not mount	—	-	Chip/Leaded resistor		✓
7	R9	0	Not mount	—	-	Chip/Leaded resistor		✓
8	R10	0	Not mount	—	—	Chip/Leaded resistor		√
9	R17	0	Not mount	—	-	Chip/Leaded resistor		✓
10	R18	0	Not mount	—	-	Chip/Leaded resistor		✓
11	R21	0	Not mount	—	—	Chip/Leaded resistor		√
12	R22	0	Not mount	—	—	Chip/Leaded resistor		√
13	R23	0	Not mount	—	-	Chip/Leaded resistor		✓
14	R24	0	Not mount	—	—	Chip/Leaded resistor		√
15	R25	0	Not mount	—	—	Chip/Leaded resistor		✓
16	R26	0	Not mount	—	—	Chip/Leaded resistor		√
17	R27	0	Not mount	—	—	Chip/Leaded resistor		√
18	R28	0	Not mount	—	—	Chip/Leaded resistor		√
19	R29	0	Not mount	—	—	Chip/Leaded resistor		√
20	R30	0	Not mount	—	-	Chip/Leaded resistor		✓
21	R31	0	Not mount	—	-	Chip/Leaded resistor		✓
22	R32	0	Not mount	-	_	Chip/Leaded resistor		√
23	R33	1	0.1Ω	-	_	Leaded resistor		
24	R36	0	Not mount	_	_	Chip/Leaded resistor		√
25	R37	0	Not mount	_	—	Chip/Leaded resistor		√

26	R38	0	Not mount	Τ_	_	Chip/Leaded resistor	√
27	R39	0	Not mount			Chip/Leaded resistor	 ✓
28	C1	1	360pF 50V			Chip capacitor	•
20	C2	1	0.1µF 50V	_	_	Chip capacitor	
30	C3	1	0.1µF 50V 0.01µF 50V	-			
-	C4			-		Capacitor	
31		1	0.01µF 50V	-	—	Chip capacitor	
32	C5	1	0.01µF 50V	-	—	Chip capacitor	
33	C6	1	0.01µF 50V	-	-	Chip capacitor	
34	С7	1	0.1µF 50V	-	-	Chip capacitor	
35	C8	1	10µF 50V	-	-	Electrolytic capacitor	
36	C10	0	Not mount	-	_	Capacitor	\checkmark
37	C11	0	Not mount	-	-	Capacitor	\checkmark
38	C15	0	Not mount	-	_	Capacitor	\checkmark
39	C17	0	Not mount	_	_	Capacitor	\checkmark
40	C18	0	Not mount	—	_	Capacitor	\checkmark
41	C19	0	Not mount	-	—	Capacitor	\checkmark
42	C20	0	Not mount	-	_	Capacitor	√
43	C21	0	Not mount	-	—	Capacitor	√
44	C22	0	Not mount	_	_	Capacitor	√
45	C23	0	Not mount	_	_	Capacitor	\checkmark
46	C24	0	Not mount	_	_	Capacitor	\checkmark
47	C25	0	Not mount	_	_	Capacitor	\checkmark
48	C26	0	Not mount	_	_	Capacitor	\checkmark
49	JP1	1	Pin header 2P	_	_	Single row plugs	
50		1	Jump socket	_	_	Position Shunt Connector	
51	JP2	1	Pin header 2P	-	_	Single row plugs	
52		1	Jump socket	 _	_	Position Shunt Connector	
53	JP3	1	Pin header 6P	 _		Dual row plugs	
54		0	Jump socket	_	_	Position Shunt Connector	√
55	JP4	1	Pin header 6P	_	_	Dual row plugs	-
56	-	0	Jump socket	<u> _</u>		Position Shunt Connector	√
57	JP5	1	Pin header 2P	<u> </u>	I	Single row plugs	•

58		0	Jump socket	_	_	Position Shunt Connector	√
59	JP6	1	Pin header 2P	_	-	Single row plugs	
60		0	Jump socket	_	_	Position Shunt Connector	\checkmark
61	JP7	1	Pin header 2P	_	_	Single row plugs	
62		0	Jump socket	-	_	Position Shunt Connector	\checkmark
63	JP8	1	Pin header 2P	-	-	Single row plugs	
64		1	Jump socket	-	-	Position Shunt Connector	
65	JP9	1	Pin header 2P	-	-	Single row plugs	
66		0	Jump socket	-	-	Position Shunt Connector	√
67	JP10	1	Pin header 2P	-	-	Single row plugs	
68		0	Jump socket	-	-	Position Shunt Connector	\checkmark
69	JP11	1	Pin header 2P	-	-	Single row plugs	
70		0	Jump socket	-	-	Position Shunt Connector	√
71	JP12	1	Pin header 2P	-	-	Single row plugs	
72		1	Jump socket	-	-	Position Shunt Connector	
73	JP13	1	Pin header 2P	-	-	Single row plugs	
74		1	Jump socket	-	-	Position Shunt Connector	
75	JP14	1	Pin header 2P	—	—	Single row plugs	
76		0	Jump socket	-	-	Position Shunt Connector	\checkmark
77	JP15	1	Pin header 2P	-	-	Single row plugs	
78		0	Jump socket	—	—	Position Shunt Connector	\checkmark
79	JP16	1	Pin header 2P	—	—	Single row plugs	
80		0	Jump socket	—	—	Position Shunt Connector	\checkmark
81	JP19	1	Pin header 2P	—	—	Single row plugs	
82		1	Jump socket	_	_	Position Shunt Connector	
83	SW1	1	Toggle switch	—	—	Toggle switch	
84	SW2	1	Toggle switch	—	—	Toggle switch	
85	SW3	1	Pin header 3P	_	_	Single row plugs	
86		1	Jump socket	-		Position Shunt Connector	
87	SW4	1	Pin header 3P	_	_	Single row plugs	
88		1	Jump socket	_	_	Position Shunt Connector	
89	SW5	1	Pin header 3P	-	-	Single row plugs	

90		1	Jump socket	_	_	Position Shunt Connector	
91	VR2	1	50kΩ	—	—	Variable resisitor	
92	VR3	1	50kΩ	—	—	Variable resisitor	
93	VR4	1	50kΩ	—	-	Variable resisitor	

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